PCN Number: 20181214		81214000	0.0	PCN Da	PCN Date:		December 14, 2018	
Title: Datasheet for THS3215								
Customer Contact: PCN Manager						ot:	Quality Services	
Proposed 1st Ship Da	te:	March 14	ł, 2019					
Change Type:								
Assembly Site			Design			Wafe	r Bump Site	
Assembly Process			Data Sheet				r Bump Material	
Assembly Materials			Part number ch	ange			r Bump Process	
Mechanical Specification			Test Site		Щ	Wafer Fab Site		
Packing/Shipping/Labeling			Test Process				r Fab Materials	
						Wafer Fab Process		
Notification Details								
Description of Change:								
Texas Instruments Incorporated is announcing an information only notification.								
The product datasheet(s) is being updated as summarized below.								
TEXAS INSTRUMENTS THS321							THS3215	
SBOS780B –MARCH 2016 – REVISED DECEMBER 2018								
Changes from Revision A (Δnril 20)16) to Revis	ion B				Page	
Changes from Revision A (-					Page	
Changed DC output impe	dance p	parameter: de	eleted maximum speci	fication, chan		st level f	from A to C 6	
Changed DC output impe Changed DC output impe	dance p	parameter: de parameter: de	eleted maximum speci eleted maximum speci	fication, chan	ged te	st level t	from A to C	
Changed DC output impe Changed DC output impe	dance p	parameter: de parameter: de	eleted maximum speci eleted maximum speci	fication, chan	ged te	st level t	from A to C 6	
Changed DC output impe Changed DC output impe	dance p dance p eximum	parameter: de parameter: de specifications	eleted maximum speci eleted maximum speci s from <i>DC output impe</i>	fication, chan	ged te	st level t	from A to C	
Changed DC output impe Changed DC output impe Deleted minimum and ma	dance p dance p eximum	parameter: de parameter: de specifications	eleted maximum speci eleted maximum speci s from <i>DC output impe</i>	fication, chan	ged te	st level t	from A to C	
Changed DC output impe Changed DC output impe Deleted minimum and ma The datasheet number	dance p dance p eximum	parameter: de parameter: de specifications	eleted maximum speci eleted maximum speci s from <i>DC output impe</i>	fication, chan	ged te	st level t	from A to C	
Changed DC output impe Changed DC output impe Deleted minimum and ma The datasheet number Device Family	dance paximum	parameter: de parameter: de specifications e changing	eleted maximum speci eleted maximum speci is from <i>DC output impe</i> g. Change From:	fication, chan	ged te	st level t	from A to C	
Changed DC output impe Changed DC output impe Deleted minimum and ma The datasheet number Device Family THS3215	dance paximum	parameter: de parameter: de specifications e changing	eleted maximum speci eleted maximum speci is from <i>DC output impe</i> g. Change From:	fication, chan	ged te	st level t	from A to C	
Changed DC output impe Changed DC output impe Deleted minimum and ma The datasheet number Device Family THS3215 http://www.ti.com/productions/	dance parameter dance paramete	parameter: de parameter: de parameter: de specifications e changing	eleted maximum speci eleted maximum speci is from <i>DC output impe</i> g. Change From: SBOS780A	fication, chan	ged te	st level t	from A to C	
Changed DC output impe Changed DC output impe Deleted minimum and ma The datasheet number Device Family THS3215 http://www.ti.com/proc Reason for Change:	dance parameter dance parameter will be duct/T	parameter: de parameter: de parameter: de parameter: de specifications e changing HS3215	eleted maximum speci eleted maximum speci is from DC output imper g. Change From: SBOS780A	fication, chang fication, chang edance param	ged te	st level f	from A to C	
Changed DC output impe Changed DC output impe Deleted minimum and ma The datasheet number Device Family THS3215 http://www.ti.com/proc Reason for Change: To accurately reflect de	dance produce produce will be duct/T	parameter: de parameter: de parameter: de specifications e changing THS3215	eleted maximum special eleted ele	fication, chang fication, chang edance param	ged te	st level f	from A to C	
Changed DC output impe Changed DC output impe Deleted minimum and ma The datasheet number Device Family THS3215 http://www.ti.com/proc Reason for Change: To accurately reflect de Anticipated impact of	dance parameter will be duct/T	parameter: de parameter: de parameter: de parameter: de specifications e changing EHS3215 Characteris Form, Fu	eleted maximum specieleted maximum specieleted maximum species from DC output impersor. Change From: SBOS780A Stics. Inction, Quality anges as indicate	fication, changed ance parameter or Reliated above.	ged te	st level f	from A to C	
Changed DC output impe Changed DC output impe Deleted minimum and ma The datasheet number Device Family THS3215 http://www.ti.com/prod Reason for Change: To accurately reflect de Anticipated impact of Electrical specification	dance parameter will be duct/T	parameter: de parameter: de parameter: de parameter: de specifications e changing EHS3215 Characteris Form, Fu	eleted maximum specieleted maximum specieleted maximum species from DC output impersor. Change From: SBOS780A Stics. Inction, Quality anges as indicate	fication, changed ance parameter or Reliated above.	ged te	st level f	from A to C	
Changed DC output impe Changed DC output impe Deleted minimum and ma The datasheet number Device Family THS3215 http://www.ti.com/proc Reason for Change: To accurately reflect de Anticipated impact of Electrical specification Changes to product in	dance parameter will be duct/T	parameter: de parameter: de parameter: de parameter: de specifications e changing EHS3215 Characteris Form, Fu	eleted maximum specieleted maximum specieleted maximum species from DC output impersor. Change From: SBOS780A Stics. Inction, Quality anges as indicate	fication, changed ance parameter or Reliated above.	ged te	st level f	from A to C	

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com